

## Table of contents

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<b>European Foreword</b> .....	<b>6</b>
<b>Introduction</b> .....	<b>7</b>
<b>1 Scope</b> .....	<b>8</b>
<b>2 Normative references</b> .....	<b>9</b>
<b>3 Terms, definitions and abbreviated terms</b> .....	<b>10</b>
3.1 Terms and definitions from other standards .....	10
3.2 Terms and definitions specific to the present standard .....	11
3.3 Abbreviated terms.....	13
3.4 Nomenclature .....	15
<b>4 Verification</b> .....	<b>16</b>
4.1 Verification process .....	16
4.2 Multipactor verification plan .....	18
4.2.1 Generation and updating.....	18
4.2.2 Description .....	18
4.3 Power requirements.....	19
4.3.1 General power requirements.....	19
4.4 Classification of equipment or component type.....	20
4.4.1 General classification of equipment or component type .....	20
4.5 Verification routes.....	22
4.6 Single carrier .....	23
4.6.1 General .....	23
4.6.2 Verification by analysis.....	23
4.6.3 Verification by test.....	26
4.7 Multicarrier.....	27
4.7.1 General .....	27
4.7.2 Verification by analysis.....	27
4.7.3 Verification by test.....	30
<b>5 Design analysis</b> .....	<b>31</b>
5.1 Overview .....	31

5.2	Field analysis.....	31
5.3	Multipactor design analysis.....	32
5.3.1	Frequency selection.....	32
5.3.2	Design analysis levels.....	32
5.3.3	Available data for Multipactor analysis.....	37
<b>6</b>	<b>Multipactor - Test conditions.....</b>	<b>45</b>
6.1	Cleanliness.....	45
6.2	Pressure.....	45
6.3	Temperature.....	46
6.4	Signal characteristics.....	47
6.4.1	Applicable bandwidth.....	47
6.4.2	Single-frequency test case.....	47
6.4.3	Multi-frequency test case.....	47
6.4.4	Pulsed testing.....	49
6.5	Electron seeding.....	50
6.5.1	General.....	50
6.5.2	Multipactor test in CW operation.....	50
6.5.3	Multipactor test in pulsed operation.....	50
6.5.4	Multipactor test in multi-carrier operation.....	50
6.5.5	Seeding sources.....	50
6.5.6	Seeding verification.....	51
<b>7</b>	<b>Multipactor - Methods of detection.....</b>	<b>52</b>
7.1	General.....	52
7.2	Detection methods.....	52
7.3	Detection method parameters.....	53
7.3.1	Verification.....	53
7.3.2	Sensitivity.....	53
7.3.3	Rise time.....	54
<b>8</b>	<b>Multipactor - Test procedure.....</b>	<b>55</b>
8.1	General.....	55
8.2	Test bed configuration.....	55
8.3	Test bed validation.....	56
8.4	Test sequence.....	57
8.5	Acceptance criteria.....	61
8.5.1	Definitions.....	61
8.5.2	Multipactor Free Equipment or component.....	61

8.5.3	Steps in case of Discharges or Events during test.....	61
8.5.4	Investigation of Test Anomalies.....	66
8.6	Test procedure .....	66
8.7	Test reporting .....	67
<b>9</b>	<b>Secondary electron emission yield requirements .....</b>	<b>68</b>
9.1	General.....	68
9.2	SEY measurements justification .....	68
9.3	Worst case SEY measurement.....	68
9.4	SEY measurements conditions .....	69
9.4.1	Environmental conditions .....	69
9.4.2	SEY test bed conditions .....	69
9.4.3	SEY sample characteristics.....	70
9.5	SEY measurements procedure .....	70
9.5.1	SEY Measurements procedure documents .....	70
9.5.2	SEY measurement calibration .....	71
9.6	ECSS SEY data selection.....	71
	<b>Annex A (informative) Multipactor document delivery per review .....</b>	<b>72</b>
	<b>Bibliography.....</b>	<b>74</b>
<b>Figures</b>		
	Figure 3-1: Minimum inflexion point for Silver multipactor chart.....	12
	Figure 4-1: Verification routes per component/equipment type and qualification status for multipactor conformance .....	22
	Figure 5-1: Multipactor chart for standard Aluminium obtained with parameters from Table 9-1 .....	42
	Figure 5-2: Multipactor chart for standard Copper obtained with parameters from Table 9-1.....	42
	Figure 5-3: Multipactor chart for standard Silver obtained with parameters from Table 9-1.....	43
	Figure 5-4: Multipactor chart for standard Gold obtained with parameters from Table 9-1.....	43
	Figure 5-5: Comparison of Multipactor charts for all standard materials obtained with parameters from Table 9-1 .....	44
	Figure 8-1: Illustration of test sequence.....	60
	Figure 8-2: Illustration of test sequence following first Event .....	63
	Figure 8-3: Illustration of test sequence following first potential discharge.....	65

## Tables

Table 4-1: Classification of equipment or component type according to the qualification status and heritage from a multipactor point of view (adapted from Table 5-1 of ECSS-E-ST-10-02).....	17
Table 4-2: Classification of equipment or component type according to the material and the geometry .....	21
Table 4-3: Analysis margins w.r.t. nominal power applicable to P1 and P2 equipment or components with Bm or Cm category verified by analysis .....	24
Table 4-4: Analysis margins w.r.t. nominal power applicable to P1 and P2 equipment or components with Dm category verified by analysis .....	25
Table 4-5: Test margins w.r.t. nominal power applicable to P1, P2 and P3 equipment or components verified by test.....	26
Table 4-6: Analysis margins applicable to P1 and P2 equipment or components with Bm or Cm category verified by analysis .....	28
Table 4-7: Analysis margins applicable to P1 and P2 equipment or components with Dm category verified by analysis.....	29
Table 4-8: Test margins w.r.t. nominal power applicable to P1, P2 and P3 equipment or components verified by test.....	30
Table 5-1: Tabulated values of the lowest breakdown voltage threshold boundary of the multipactor charts, computed with the SEY data of Table 9-1.....	38
Table 9-1: SEY parameters for Al, Cu, Au and Ag materials.....	71
Table A-1 : Multipactor deliverable document per review.....	73